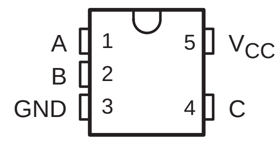
- **Qualification in Accordance With AEC-Q100†**
- **Qualified for Automotive Applications**
- **Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **1.65-V to 5.5-V V_{CC} Operation**
- **Inputs Accept Voltages to 5.5 V**
- **High On-Off Output Voltage Ratio**

† Contact factory for details. Q100 qualification data available on request.

- **High Degree of Linearity**
- **High Speed, Typically 0.5 ns (V_{CC} = 3 V, C_L = 50 pF)**
- **Low On-State Resistance, Typically ≈5.5 Ω (V_{CC} = 4.5 V)**
- **Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II**

**DBV or DCK PACKAGE
(TOP VIEW)**



description/ordering information

This single analog switch is designed for 1.65-V to 5.5-V V_{CC} operation.

The SN74LVC1G66 can handle both analog and digital signals. The device permits signals with amplitudes of up to 5.5 V (peak) to be transmitted in either direction.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

ORDERING INFORMATION

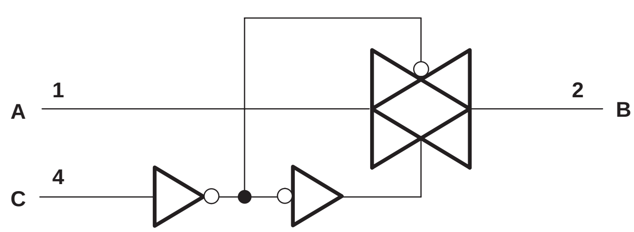
T_A	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING§
−40°C to 125°C	SOT (SOT-23) − DBV	Reel of 2875	1P1G66QDBVRQ1	C66_
	SOT (SOT-70) − DCK	Reel of 2875	1P1G66QDCKRQ1	C6_

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
§ DBV: The actual top-side marking has one additional character that designates the assembly/test site.

FUNCTION TABLE

CONTROL INPUT (C)	SWITCH
L	OFF
H	ON

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1) . . . . −0.5 V to 6.5 V
Input voltage range, V_I (see Notes 1 and 2) . . . . −0.5 V to 6.5 V
Switch I/O voltage range, $V_{I/O}$ (see Notes 1, 2, and 3) . . . . −0.5 V to V_{CC} + 0.5 V
Control input clamp current, I_{IK} (V_I < 0) . . . . −50 mA
I/O port diode current, I_{IOK} ($V_{I/O}$ < 0) . . . . −50 mA
On-state switch current, I_T ($V_{I/O}$ = 0 to V_{CC}) . . . . ±50 mA
Continuous current through V_{CC} or GND . . . . ±100 mA
Package thermal impedance, θ_{JA} (see Note 2): DBV package . . . . 206°C/W
DCK package . . . . 252°C/W
Storage temperature range, T_{stg} . . . . −65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltages are with respect to ground, unless otherwise specified.
2. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
3. This value is limited to 5.5 V maximum.
4. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 5)

			MIN	MAX	UNIT
V_{CC}	Supply voltage		1.65	5.5	V
$V_{I/O}$	I/O port voltage		0	V_{CC}	V
V_{IH}	High-level input voltage, control input	V_{CC} = 1.65 V to 1.95 V	$V_{CC} \times 0.65$		V
		V_{CC} = 2.3 V to 2.7 V	$V_{CC} \times 0.7$		
		V_{CC} = 3 V to 3.6 V	$V_{CC} \times 0.7$		
		V_{CC} = 4.5 V to 5.5 V	$V_{CC} \times 0.7$		
V_{IL}	Low-level input voltage, control input	V_{CC} = 1.65 V to 1.95 V		$V_{CC} \times 0.35$	V
		V_{CC} = 2.3 V to 2.7 V		$V_{CC} \times 0.3$	
		V_{CC} = 3 V to 3.6 V		$V_{CC} \times 0.3$	
		V_{CC} = 4.5 V to 5.5 V		$V_{CC} \times 0.3$	
V_I	Control input voltage		0	5.5	V
$\Delta t/\Delta v$	Input transition rise/fall time	V_{CC} = 1.65 V to 1.95 V		20	ns/V
		V_{CC} = 2.3 V to 2.7 V		20	
		V_{CC} = 3 V to 3.6 V		10	
		V_{CC} = 4.5 V to 5.5 V		10	
T_A	Operating free-air temperature		−40	125	°C

NOTE 5: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V_{CC}	MIN	TYP†	MAX	UNIT
r_{on}	On-state switch resistance	$V_I = V_{CC}$ or GND, $V_C = V_{IH}$ (see Figure 1)	I_S = 4 mA	1.65 V		12	35	Ω
			I_S = 8 mA	2.3 V		9	30	
			I_S = 16 mA	3 V		9	30	
			I_S = 16 mA	4.5 V		5.5	25	
$r_{on(p)}$	Peak on resistance	$V_I = V_{CC}$ to GND, $V_C = V_{IH}$ (see Figure 1)	I_S = 4 mA	1.65 V		74.5	165	Ω
			I_S = 8 mA	2.3 V		20	60	
			I_S = 16 mA	3 V		12.5	35	
			I_S = 16 mA	4.5 V		7.5	25	
$I_{S(off)}$	Off-state switch leakage current	$V_I = V_{CC}$ and V_O = GND or V_I = GND and $V_O = V_{CC}$, $V_C = V_{IL}$ (see Figure 2)		5.5 V			±1	μA
							±0.1†	
$I_{S(on)}$	On-state switch leakage current	$V_I = V_{CC}$ or GND, $V_C = V_{IH}$, V_O = Open (see Figure 3)		5.5 V			±1	μA
							±0.1†	
I_I	Control input current	$V_C = V_{CC}$ or GND		5.5 V			±1	μA
							±0.1†	
I_{CC}	Supply current	$V_C = V_{CC}$ or GND		5.5 V			10	μA
							1†	
ΔI_{CC}	Supply current change	$V_C = V_{CC} - 0.6$ V		5.5 V			500	μA
C_{ic}	Control input capacitance			5 V		2		pF
$C_{io(off)}$	Switch input/output capacitance			5 V		6		pF
$C_{io(on)}$	Switch input/output capacitance			5 V		13		pF

† T_A = 25°C

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 1.8 V ± 0.15 V		V_{CC} = 2.5 V ± 0.2 V		V_{CC} = 3.3 V ± 0.3 V		V_{CC} = 5 V ± 0.5 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{pd}‡	A or B	B or A		5.5		3.2		2.8		2.6	ns
t_{en}§	C	A or B	2.5	14	1.9	9.5	1.8	8	1.5	7.2	ns
t_{dis}¶	C	A or B	2.2	12	1.4	8.9	2	8.4	1.4	6.9	ns

‡ t_{PLH} and t_{PHL} are the same as t_{pd}. The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

§ t_{PZL} and t_{PZH} are the same as t_{en}.

¶ t_{PLZ} and t_{PHZ} are the same as t_{dis}.

analog switch characteristics, T_A = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V_{CC}	TYP	UNIT
Frequency response† (switch ON)	A or B	B or A	C_L = 50 pF, R_L = 600 Ω, f_{in} = sine wave (see Figure 5)	1.65 V	35	MHz
				2.3 V	120	
				3 V	175	
				4.5 V	195	
			C_L = 5 pF, R_L = 50 Ω, f_{in} = sine wave (see Figure 5)	1.65 V	>300	
				2.3 V	>300	
				3 V	>300	
				4.5 V	>300	
Crosstalk (control input to signal output)	C	A or B	C_L = 50 pF, R_L = 600 Ω, f_{in} = 1 MHz (square wave) (see Figure 6)	1.65 V	35	mV
				2.3 V	50	
				3 V	70	
				4.5 V	100	
Feedthrough attenuation‡ (switch OFF)	A or B	B or A	C_L = 50 pF, R_L = 600 Ω, f_{in} = 1 MHz (sine wave) (see Figure 7)	1.65 V	−58	dB
				2.3 V	−58	
				3 V	−58	
				4.5 V	−58	
			C_L = 5 pF, R_L = 50 Ω, f_{in} = 1 MHz (sine wave) (see Figure 7)	1.65 V	−42	
				2.3 V	−42	
				3 V	−42	
				4.5 V	−42	
Sine-wave distortion	A or B	B or A	C_L = 50 pF, R_L = 10 kΩ, f_{in} = 1 kHz (sine wave) (see Figure 8)	1.65 V	0.1	%
				2.3 V	0.025	
				3 V	0.015	
				4.5 V	0.01	
			C_L = 50 pF, R_L = 10 kΩ, f_{in} = 10 kHz (sine wave) (see Figure 8)	1.65 V	0.15	
				2.3 V	0.025	
				3 V	0.015	
				4.5 V	0.01	

† Adjust f_{in} voltage to obtain 0 dBm at output. Increase f_{in} frequency until dB meter reads −3 dB.
‡ Adjust f_{in} voltage to obtain 0 dBm at input.

operating characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS	V_{CC} = 1.8 V	V_{CC} = 2.5 V	V_{CC} = 3.3 V	V_{CC} = 5 V	UNIT
			TYP	TYP	TYP	TYP	
C_{pd}	Power dissipation capacitance	f = 10 MHz	8	9	9	11	pF

PARAMETER MEASUREMENT INFORMATION

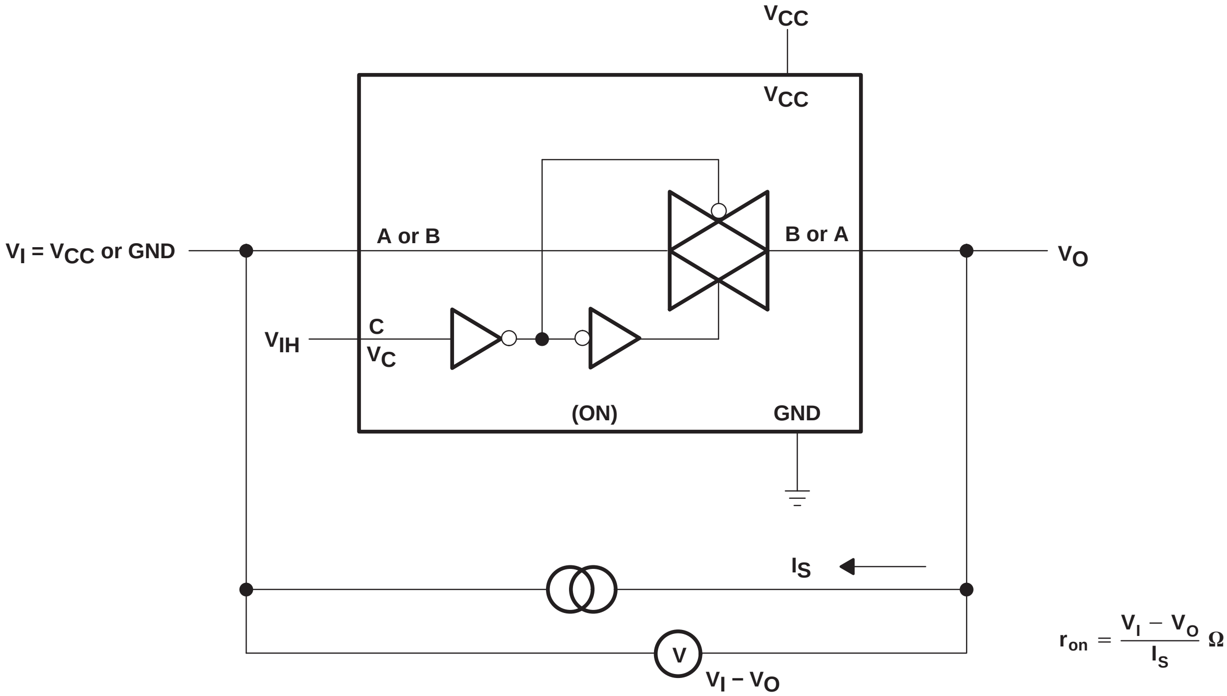


Figure 1. On-State Resistance Test Circuit

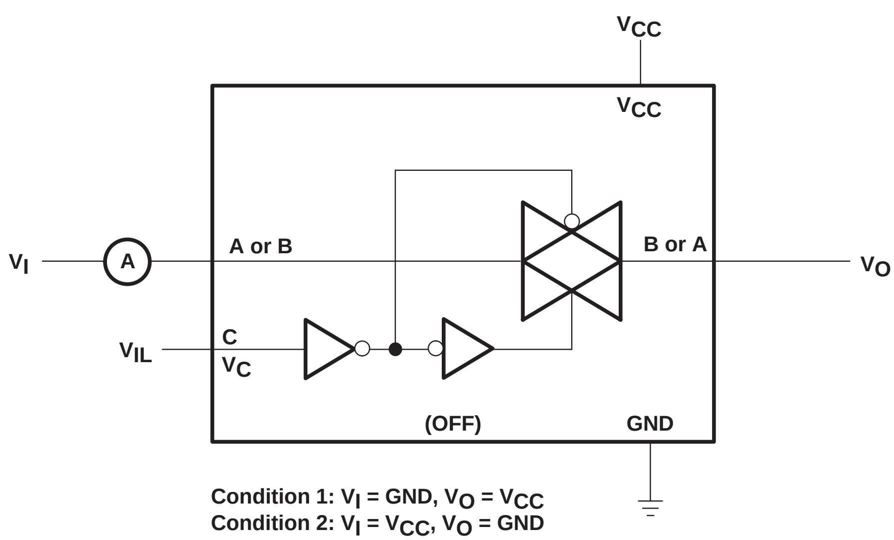


Figure 2. Off-State Switch Leakage-Current Test Circuit

PARAMETER MEASUREMENT INFORMATION

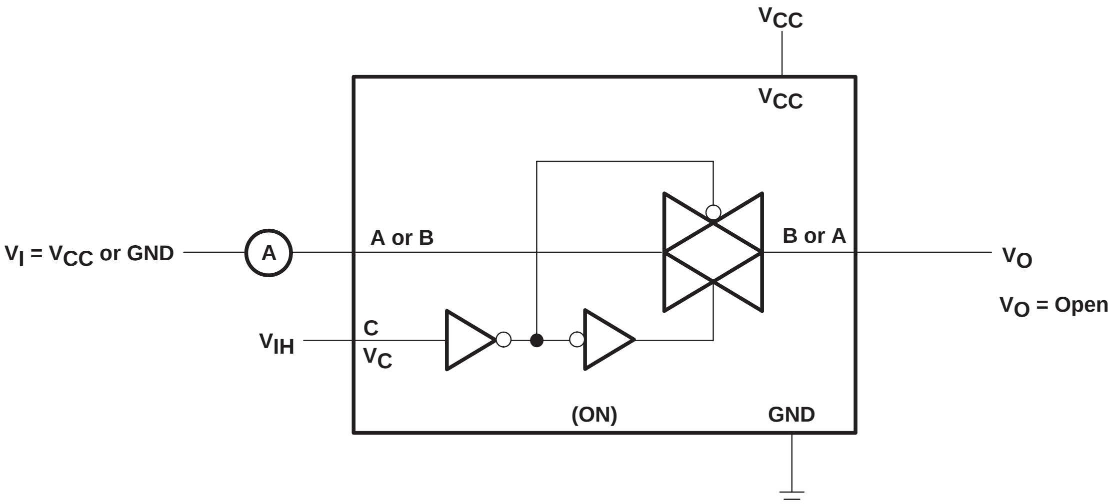
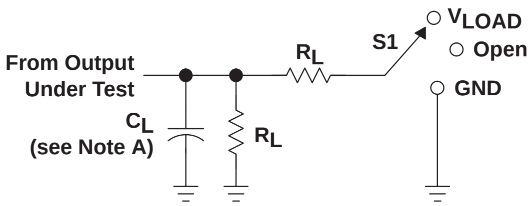


Figure 3. On-State Leakage-Current Test Circuit

PARAMETER MEASUREMENT INFORMATION

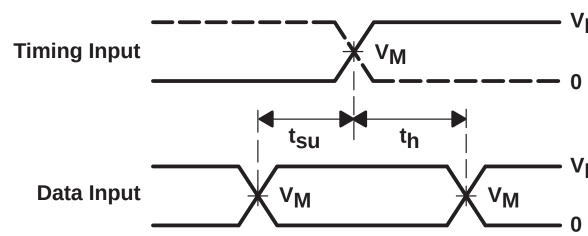


LOAD CIRCUIT

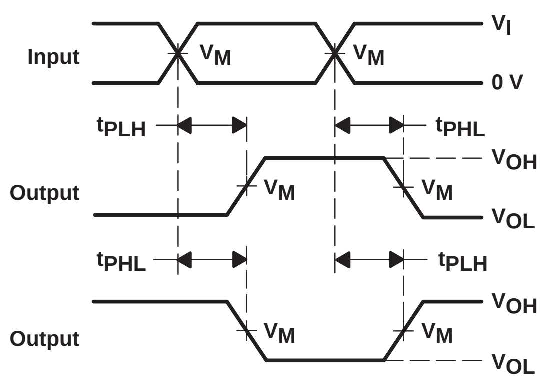
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND

V_{CC}	INPUTS		V_M	V_{LOAD}	C_L	R_L	V_Δ
	V_I	t_r/t_f					
1.8 V ± 0.15 V	V_{CC}	≤2 ns	$V_{CC}/2$	2 × V_{CC}	30 pF	1 kΩ	0.15 V
2.5 V ± 0.2 V	V_{CC}	≤2 ns	$V_{CC}/2$	2 × V_{CC}	30 pF	500 Ω	0.15 V
3.3 V ± 0.3 V	V_{CC}	≤2.5 ns	$V_{CC}/2$	2 × V_{CC}	50 pF	500 Ω	0.3 V
5 V ± 0.5 V	V_{CC}	≤2.5 ns	$V_{CC}/2$	2 × V_{CC}	50 pF	500 Ω	0.3 V

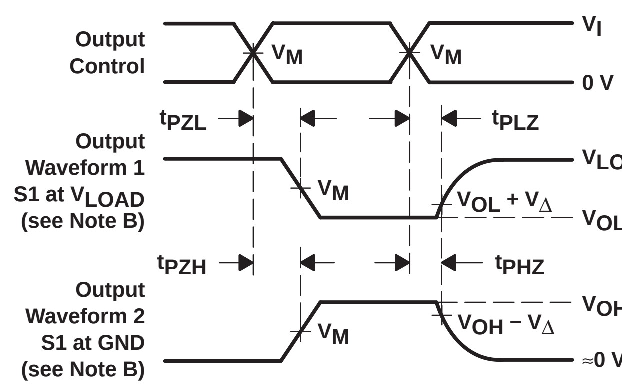
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES:
- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.
- H. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION

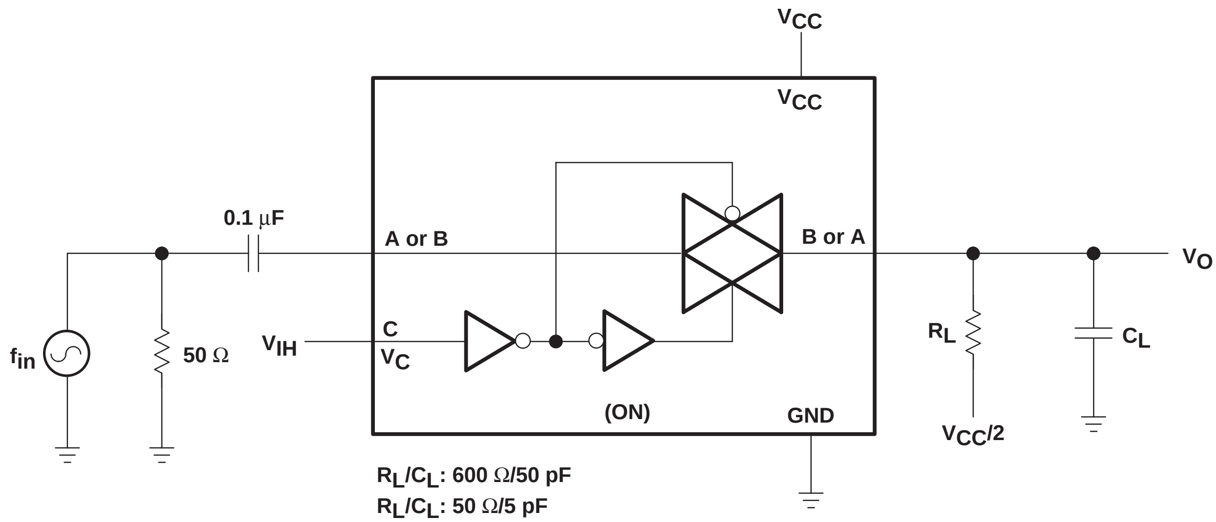


Figure 5. Frequency Response (Switch ON)

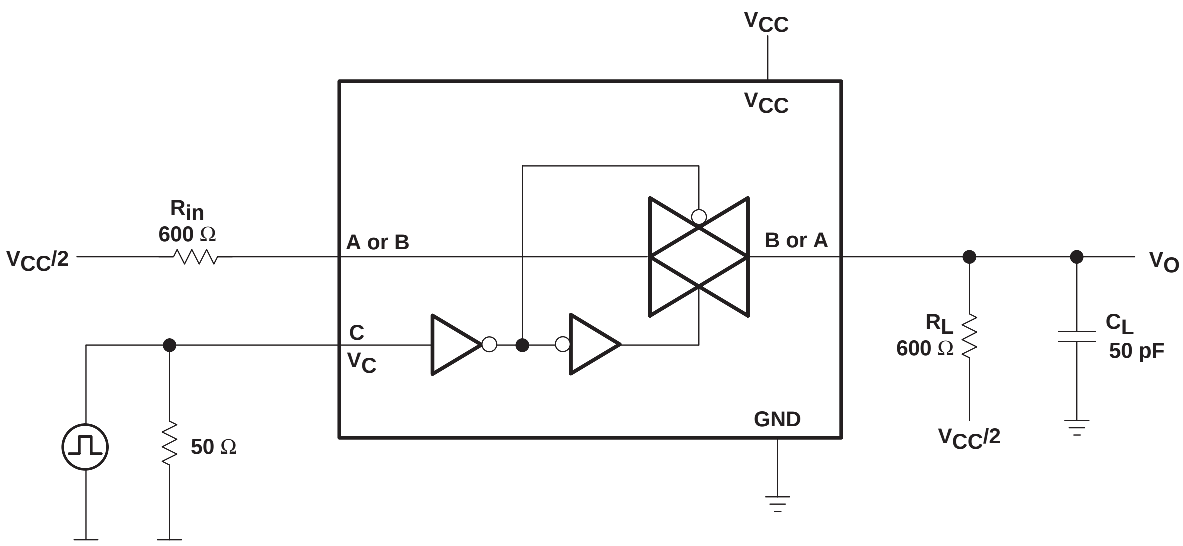


Figure 6. Crosstalk (Control Input − Switch Output)

PARAMETER MEASUREMENT INFORMATION

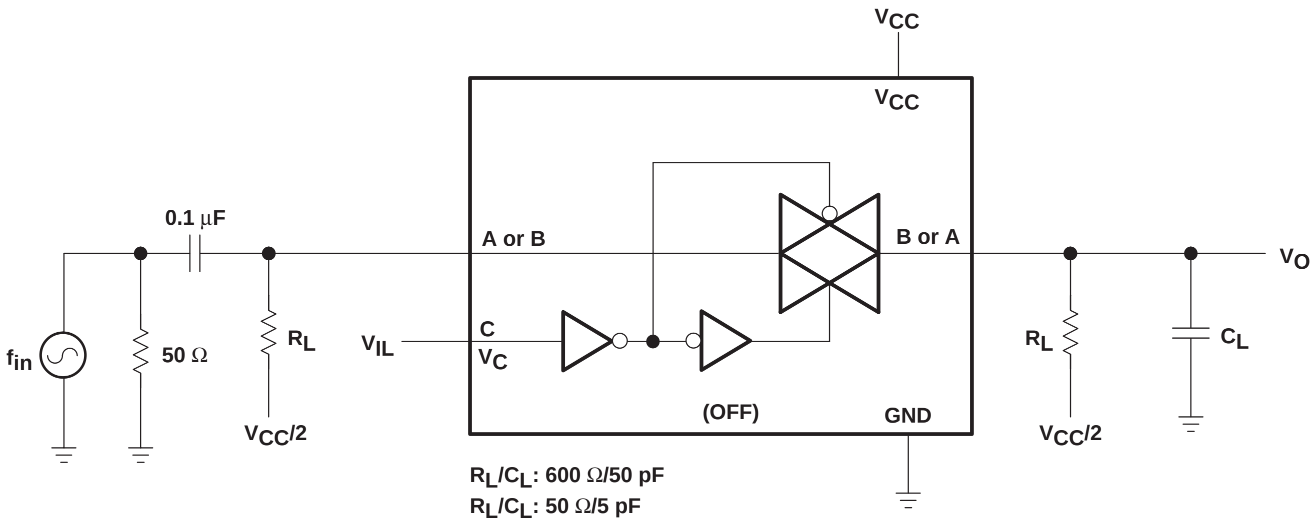


Figure 7. Feedthrough (Switch OFF)

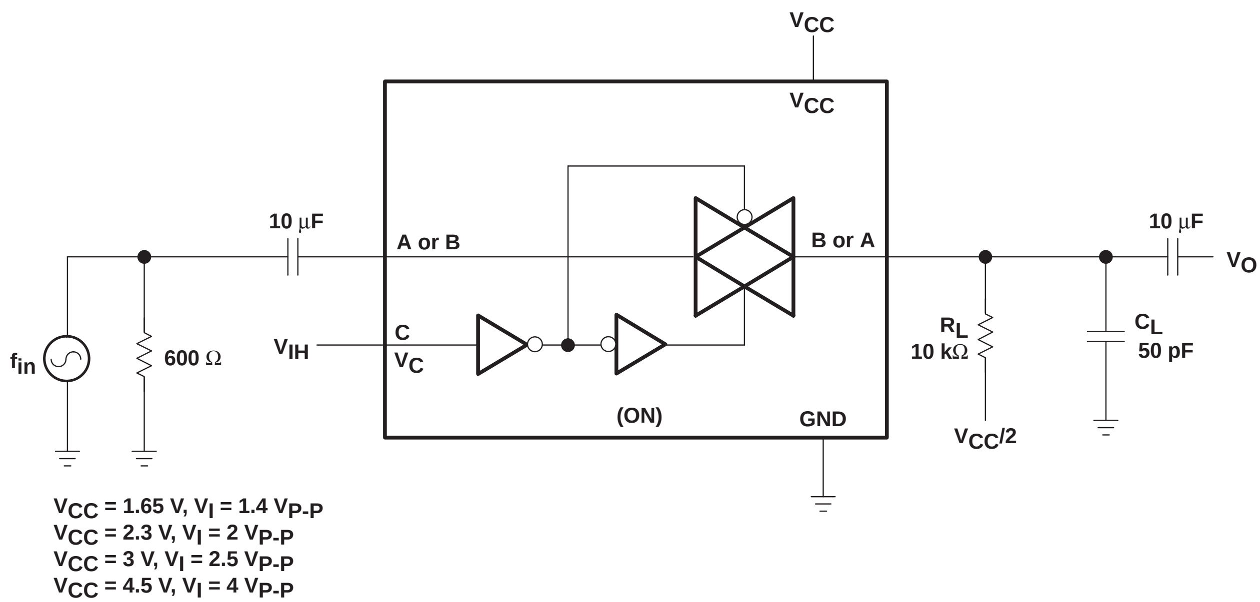
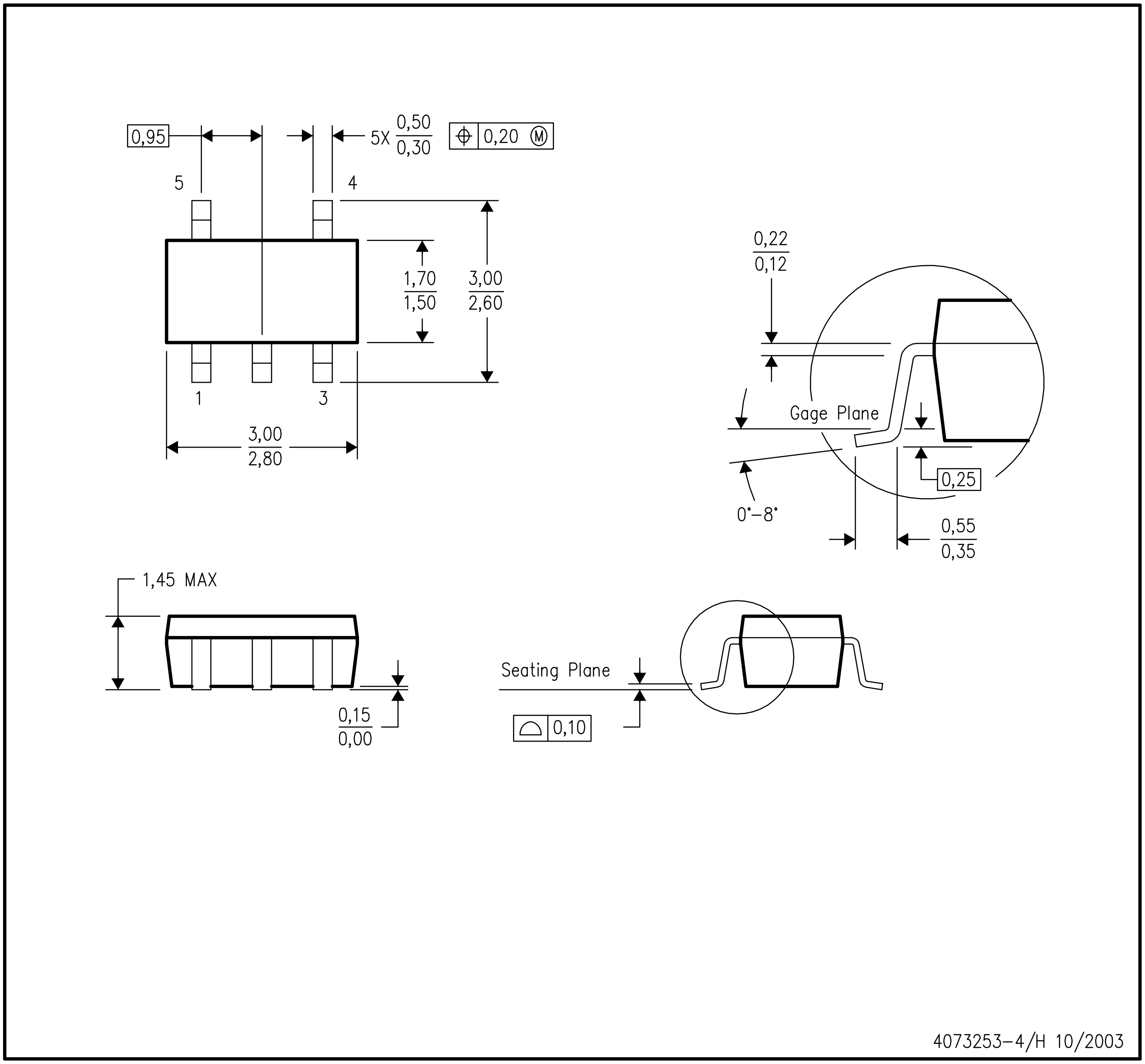


Figure 8. Sine-Wave Distortion

DBV (R-PDSO-G5) PLASTIC SMALL-OUTLINE PACKAGE



NOTES:
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-178 Variation AA.

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Mailing Address: Texas Instruments
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